



Edition 4.0 2008-07

INTERNATIONAL STANDARD

Fixed resistors for use in electronic equipment – Part 1: Generic specification





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Fixed resistors for use in electronic equipment – Part 1: Generic specification

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIXED RESISTORS FOR USE IN ELECTRONIC EQUIPMENT -

Part 1: Generic specification

FOREWORD

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International Standard IEC 60115-1 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment

This fourth edition cancels and replaces the third edition issued in 1999 and Amendment 1 (2001). It constitutes a technical revision.

This standard cancels and replaces IEC 61045-1 (1991), IEC 61045-2 (1991) and IEC 61045-2-1 (1991).

This edition contains the following significant technical changes with respect to the previous edition:

- a) implementation of Annex Q which replaces Clause 3;
- b) addition of new tests procedures in 4.34 through 4.38;
- c) removal of the property "temperature characteristics" from 4.8;

- d) introduction of a new system of test severities for the shear test in 4.32;
- e) introduction of new bias voltages for the damp heat steady-state test in 4.24;
- f) furthermore, this fourth edition cancels and replaces the third edition published in 1999 and constitutes minor revisions related to tables, figures and references.

The text of this standard is based on the following documents:

FDIS	Report on voting
40/1907/FDIS	40/1922/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

A list of all parts of the IEC 60115 series, under the general title *Fixed resistors for use in electronic equipment*, can be found on the IEC website.

All sectional specifications mentioned above do have one or more blank detail specifications being a supplementary document, containing requirements for style, layout and minimum content of detail specifications.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed.
- · withdrawn.
- · replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

FIXED RESISTORS FOR USE IN ELECTRONIC EQUIPMENT -

Part 1: Generic specification

1 General

1.1 Scope

This part of IEC 60115 is a generic specification and is applicable to fixed resistors for use in electronic equipment.

It establishes standard terms, inspection procedures and methods of test for use in sectional and detail specifications of electronic components for quality assessment or any other purpose.

1.2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60027 (all parts), Letter symbols to be used in electrical technology

IEC 60050 (all parts), International Electrotechnical Vocabulary

IEC 60060-1:1989, High-voltage test techniques – Part 1: General definitions and test requirements

IEC 60062:2004, Marking codes for resistors and capacitors

IEC 60063:1963, Preferred number series for resistors and capacitors Amendment 1(1967)
Amendment 2(1977)

IEC 60068-1:1988, Environmental testing – Part 1: General and guidance Amendment 1(1992)

IEC 60068-2-1:1990, Environmental testing – Part 2: Tests – Tests A: Cold Amendment 1(1993)

Amendment 2(1994)

IEC 60068-2-2:1974, Environmental testing – Part 2: Tests – Tests B: Dry heat Amendment 1(1993)
Amendment 2(1994)

IEC 60068-2-6:2007, Environmental testing – Part 2: Tests – Test Fc: Vibration (sinusoidal)

IEC 60068-2-11:1981, Environmental testing – Part 2: Tests – Test Ka: Salt mist

IEC 60068-2-13:1983, Environmental testing – Part 2: Tests – Test M: Low air pressure

IEC 60068-2-14:1984, Environmental testing – Part 2: Tests – Test N: Change of temperature Amendment 1(1986)

IEC 60068-2-20:1979, Environmental testing – Part 2: Tests – Test T: Soldering Amendment 2(1987)

IEC 60068-2-21:2006, Environmental testing – Part 2: Tests – Test U: Robustness of terminations and integral mounting devices

IEC 60068-2-27:1987, Environmental testing – Part 2: Tests – Test Ea and guidance: Shock

IEC 60068-2-29:1987, Environmental testing – Part 2: Tests – Test Eb and guidance: Bump

IEC 60068-2-30:2005, Environmental testing – Part 2: Tests – Test Db: Damp heat, cyclic (12 h+ 12 h cycle)

IEC 60068-2-45:1980, Environmental testing – Part 2: Tests – Test XA and guidance: Immersion in cleaning solvents
Amendment 1(1993)

IE 60068-2-54: 2006, Environmental testing – Part 2.54: Tests – Test Ta: Solderability testing of electronic components by the wetting balance method

IEC 60068-2-58:2005, Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)

IEC 60068-2-67:1995, Environmental testing – Part 2-67: Tests – Test Cy: Damp heat, steady state, accelerated test primarily intended for components

IEC 60068-2-78:2001, Environmental testing – Part 2-78: Tests – Test Cab: Damp heat, steady state

IEC 60195:1965, Method of measurement of current noise generated in fixed resistors

IEC 60286, Packaging of components for automatic handling

IEC 60294:1969, Measurement of the dimensions of a cylindrical component having two axial terminations

IEC 60410:1973, Sampling plans and procedures for inspection by attributes

IEC 60440:1973, Method of measurement of non-linearity in resistorsIEC 60617:2007, Graphical symbols for diagrams

IEC 60617, Graphical symbols for diagrams

IEC 60695-11-5:2004, Fire hazard testing – Part 11-5: Test flames – Needle-flame test method – Apparatus, confirmatory test arrangement and guidance

IEC 61193-2:2007, Quality assessment systems – Part 2: Selection and use of sampling plans for inspection of electronic components and packages

IEC 61249-2-7:2002, Materials for printed boards and other interconnecting structures – Part 2-7: Reinforced base materials clad and unclad – Epoxide woven E-glass laminated sheet of defined flammability (vertical burning test), copper-clad

IEC 61249-2-22: 2005, Materials for printed boards and other interconnecting structures – Part 2-22: Reinforced base materials clad and unclad – Modified non-halogenated epoxide woven E-glass laminated sheets of defined flammability (vertical burning test), copper-clad

IEC 61249-2-35, Materials for printed boards and other interconnecting structures – Part 2-35: Reinforced base materials clad and unclad – Modified epoxide woven E-glass laminated sheets of defined flammability (vertical burning test), copper-clad for lead-free assembly¹

IEC 61340-3-1:2006, Electrostatics – Part 3-1: Methods for simulation of electrostatic effects – Human body model (HBM) electrostatic discharge test waveforms

IEC 61760-1:2006, Surface mounting technology – Part 1: Standard method for the specification of surface mounting components (SMDs)

IEC QC 001002-3:2005, IEC Quality Assessment System for Electronic Components (IECQ) – Rules of procedure – Part 3: Approval procedures

ISO 1000:1992, SI units and recommendations for the use of their multiples and of certain other units

2 Technical data

2.1 Units and symbols

Units, graphical symbols and letter symbols should, whenever possible, be taken from the following publications:

- IEC 60027;
- IEC 60050;
- IEC 60617;
- ISO 1000.

When further items are required they shall be derived in accordance with the principles of the publications listed above.

2.2 Terms and definitions

For the purposes of this document, the following terms and definitions apply, in alphabetical order:

2.2.1

category dissipation

fraction of the rated dissipation exactly defined in the detail specification, applicable at the upper category temperature, taking account of the derating curve prescribed in the detail specification

NOTE 1 For resistors the category dissipation is zero, where the upper category temperature is the maximum element temperature.

NOTE 2 Related terminology: rated dissipation, upper category temperature, derating curve

2.2.2

category temperature range

range of ambient temperatures for which the resistor has been designed to operate continuously; this is given by the lower and upper category temperature

¹ To be published.